



TXC CORPORATION

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SPECIFICATION FOR APPROVAL

CUSTOMER : _____

PRODUCT TYPE : SMD SEAM SEALING XTAL 5.0*3.2

NOMINAL FREQ. : 16.000000MHz

TXC P/N : 7B16000113

REVISION : A1

CUSTOMER P/N : _____

PM / SALES : _____

DATE: : _____

CUSTOMER SIGNATURE & Date

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.

Attachment: Product Specification Sheet

- 1
- 2
- 3
- 4
- 5



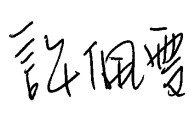
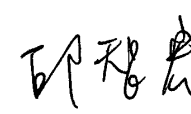
PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD SEAM SEALING XTAL 5.0*3.2

NOMINAL FREQ. : 16.000000MHz

TXC P/N : 7B16000113

REVISION : A1

Dept.	PM	PE/RD	QA	MFG
Name			Steve Joh	C.W. Lee
Date	2004/5/18	2004/5/17	2004/5/18	2004/5/17

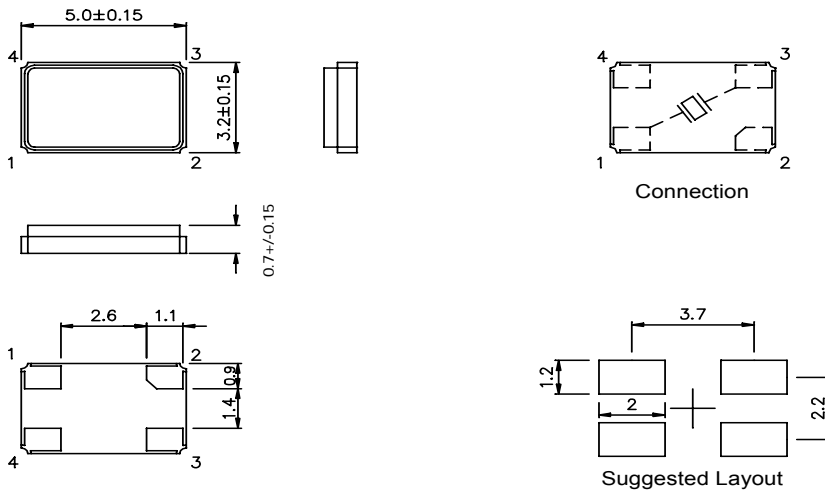
NOTE

- (1) Revision "Sx" is for engineering samples only. PM and PE/RD's approval required.
- (2) Revision "Ax" is production ready. PM, PE, QA and MFG's approval required

ELECTRICAL SPECIFICATIONS

	Parameters	SYM.	Electrical Spec.				Notes
			MIN	TYPE	MAX	UNITS	
1	Nominal Frequency	FL	16.000000			MHz	
2	Oscillation Mode		Fundamental				
3	Load Capacitance	CL			9	pF	
4	Frequency Tolerance				±10	ppm	at 25 °C ± 3 °C
5	Frequency Tolerance				±9	ppm	Over Operating Temp. Range
6	Operating Temperature		-20	~	75	°C	
7	Aging				1	ppm	1st Year
8	Circuit						Measured by HP E5100A
9	Drive Level	DL			100	uW	
10	Effective Resistance Rr	Rr			35	Ω	
11	Shunt Capacitance C0	C0			3	pF	
12	Motional Capacitance C1	C1			NA	fF	
13	Insulation Resistance				500	MΩ	at DC 100V
14	Storage Temperature Range		-40	~	85	°C	

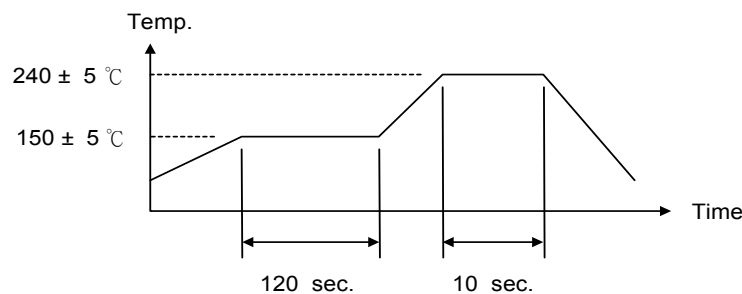
DIMENSIONS (UNIT:mm)



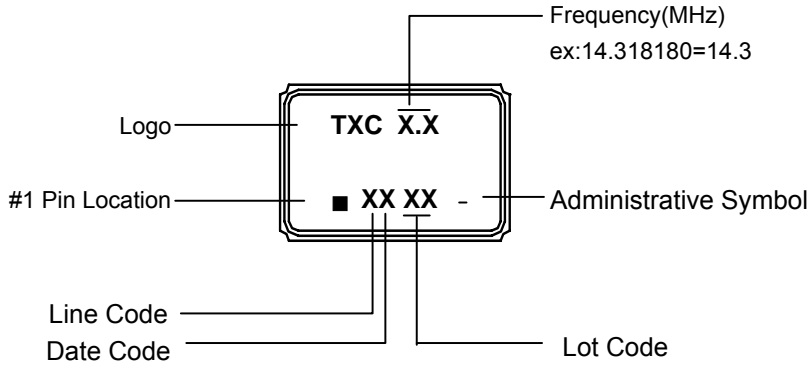
SUGGESTED REFLOW PROFILE

Total time : 200 sec. Max.

Solder melting point : 185 °C



MARKING

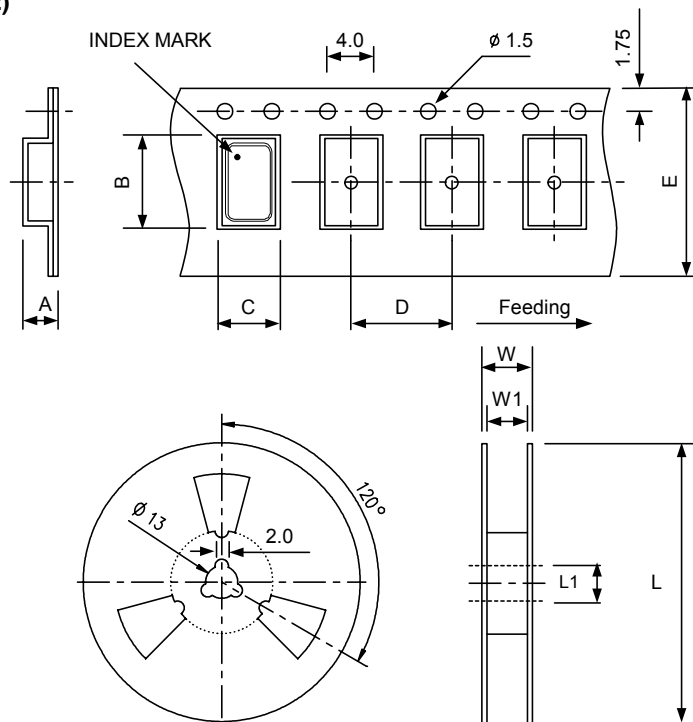


Date Code

YEAR					MONTH											
					JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2001	2005	2009	2013	2017	A	B	C	D	E	F	G	H	J	K	L	M
2002	2006	2010	2014	2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2003	2007	2011	2015	2019	a	b	c	d	e	f	g	h	j	k	l	m
2004	2008	2012	2016	2020	n	p	q	r	s	t	u	v	w	x	y	z

This date code will be cycled every four years

PACKING : (EIA-481-2)



DIMENSIONS	A	B	C	D	E	L	L1	W	W1	pcs / Reel (UNIT : mm)
		1.46	5.5	3.6	8.0	12	180	13	15.4	13

- REMARK :
- 230 mm (9.05) minimum leader which consist of carrier and/or tape followed by a minimum of 160 mm (6.3) of empty carrier tape sealed with cover tape.
 - 160 mm (6.3) minimum trailer of empty carrier tape sealed with cover tape.

RELIABILITY SPECIFICATIONS

No.	Test Item	Test Methods	REF.DOC
1	Drop Test	75 cm height, fall freely onto stainless plate 3 times.	JIS C6701
2	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutually pendicular axes each 3 times. 0.5m sec. duration time	MIL-STD-202F
3	Vibration	Frequency range 10 ~ 2000 Hz Amplitude 1.52 mm Sweep time 20 minute Pendicular axes each test time 4 hours (Total test time 12 hours)	MIL-STD-883E
4	Solderability	Temperature 215 °C ± 5°C Immersing depth 0.5 mm minimum Immersion time 10 ± 0.5 seconds Flux Rosin resin methyl alcohol solvent (1 : 4)	MIL-STD-883E
5	Resistance To Soldering Heat	Pre-heat temperature 125 °C Pre-heat time 60 ~ 120 sec. Test temperature 260 ± 5 °C Test time 5 ± 1 sec.	MIL-STD-202F
6	High Temp. Storage	+ 125 °C ± 2 °C for 1000 ± 12 hours	MIL-STD-883E
7	Low Temp. Storage	- 40 °C ± 2 °C for 1000 ± 12 hours	
8	Thermal Cycles	Total 100 cycles of the following temperature cycle 	MIL-STD-883E

<u>Rev</u>	<u>Revise page</u>	<u>Revise contents</u>	<u>Date</u>	<u>Ref.No.</u>	<u>Reviser</u>	<u>Page</u>	<u>Ver.</u>
A1	N/A	Initially revised	5/17/04	N/A	繆亞娟	1	A1
						2	A1
						3	A1
						4	A1
						5	A1
						6	A1